

UNITED STATES PATENT AND TRADEMARK OFFICE
 APPLICANT Son K. Quan et al. GROUP ART UNIT: 2831
 APPLN. NO.: 09/928,737 EXAMINER: Hung V. Ngo
 FILED: August 13, 2001 CONFIRMATION No.: 7252
 TITLE: SEMICONDUCTOR PACKAGE AND METHOD THEREFOR

Certificate of Submission

I hereby certify that this correspondence is being submitted to the U.S.P.T.O., Alexandria, VA.

Addressed per C.F.R. § 1.1(a) and deposited with the United States Postal Service with sufficient postage as first class mail.

Facsimile transmitted in accordance with C.F.R. § 1.6(d).

Submitted electronically via EFS in accordance with "Legal Framework for EFS Web".

May 6, 2010

Date of Submission

/Dee Matocha/

Signature

Dee Matocha

Printed Name of Person Signing Certificate

AMENDMENT IN FURTHERANCE OF RCE UNDER 37 CFR 1.114

Commissioner for Patents
 P.O. Box 1450
 Alexandria, VA 22313-1450

Sir:

Applicants are herein filing a Request for Continued Examination under 37 CFR 1.114 of U.S. Serial No. 09/928,737 and request entrance of the following amendments in view of the remarks presented thereafter.

FEES

Applicants continue to authorize the charging of Deposit Account No. 503079 (Freescale Semiconductor, Inc.) for any fees owed in connection with this application, or credit Deposit Account No. 503079 (Freescale Semiconductor, Inc.) for any refunds.